



PIN A1 REFERENCE

2X \( \triangle \) 0.10 \( \triangle \) C

2X |  $\bigcirc$  | 0.10

△ 0.05 C

 $6x \oslash b$ 

CAB

NOTE 3

0.10

0.05 C

С

0.10 C

A1-

**TOP VIEW** 

**SIDE VIEW** 

**BOTTOM VIEW** 



WLCSP6, 1.355x0.845 CASE 567JR ISSUE A

AB

D

C SEATING

**DATE 17 JUN 2014** 

## NOTES:

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.
- 4. DIMENSION 6 IS MEASURED AT THE MAXI-MUM BALL DIAMETER PARALLEL TO DA-TI IM C

	MILLIMETERS		
DIM	MIN	MAX	
Α		0.60	
A1	0.18	0.22	
A2	0.36 REF		
b	0.24	0.30	
D	1.355 BSC		
E	0.845 BSC		
e	0.40 BSC		

## GENERIC MARKING DIAGRAM\*



XXX = Specific Device Code

A = Assembly Location

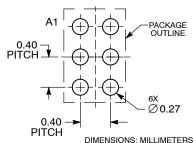
Y = Year

W = Work Week

= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present.

## RECOMMENDED SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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